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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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### General Description

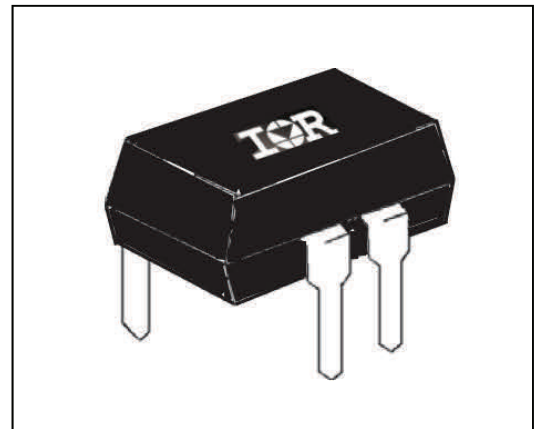
The PVI Series Photovoltaic Isolator generates an electrically isolated DC voltage upon receipt of a DC input signal. It is capable of directly driving gates of power MOSFETs or IGBTs. It utilizes a monolithic integrated circuit photovoltaic generator of novel construction as its output. The output is controlled by radiation from a GaAlAs light emitting diode (LED), which is optically isolated from the photovoltaic generator.

The PVI Series is ideally suited for applications requiring high-current and/or high-voltage switching with optical isolation between the low-level driving circuitry and high-energy or high-voltage load circuits. It can be used for directly driving gates of power MOSFETs. The dual-channel device allows its outputs to drive independent discrete power MOSFETs, or be connected in parallel or in series to provide higher current drive for power MOSFETs or higher voltage drive for IGBTs. The PVI Series Photovoltaic isolators employ fast turn-off circuitry.

These PVI Series Photovoltaic Isolators are packaged in 8-pin, molded DIP packages and available with either thru-hole or surface-mount ("gull-wing") leads, in plastic shipping tubes.

### Features

- Isolated Voltage Source
- Monolithic Construction
- Up to 8 $\mu$ A Output
- Single Output
- Solid-State Reliability



### Applications

- Load Distribution
- Industrial Controls
- Current-to-Voltage Conversion
- Custom Solid-State Relay

### Part Identification

PVI5080NPbF	thru-hole
PVI5080NSPbF	Surface-mount (gull-wing)

**Electrical Specifications** ( $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$  unless otherwise specified)

<b>INPUT CHARACTERISTICS</b>	<b>Limits</b>	<b>Units</b>
Input Current Range (see figure 4)	2.0 to 50	mA <sub>(DC)</sub>
Maximum Forward Voltage Drop @ 10mA, 25°C (see figure 5)	1.4	V <sub>(DC)</sub>
Maximum Reverse Voltage	6.0	V <sub>(DC)</sub>
Maximum Reverse Current @ -6.0V (DC), 25°C	100	μA <sub>(DC)</sub>
Maximum Pulsed Input Current @ 25°C (see figure 6)	1.0	A <sub>(peak)</sub>

<b>OUTPUT CHARACTERISTICS</b>	<b>Limits</b>	<b>Units</b>
Maximum Forward Voltage @ 10μA	8.0 per channel	V <sub>(DC)</sub>
Maximum Reverse Current @ -10V <sub>DC</sub>	10	μA <sub>(DC)</sub>

<b>COUPLED CHARACTERISTICS</b>	<b>Limits</b>	<b>Units</b>
Minimum Open Circuit Voltage @ ILED = 10mA, 25°C, RL = >10MΩ (see figures 1 to 2)	5.0	V <sub>(DC)</sub>
Minimum Short Circuit Current @ ILED = 14mA, 25°C (see figures 1 to 2)	8.0	μA <sub>(DC)</sub>
Maximum Capacitance (Input/Output)	1.0	pF
Maximum Ton Time @ ILED=10mA, CLOAD=10pF (See Figure7) RL > 20MΩ RL=10MΩ RL=4.7MΩ	300	μS
	160	μS
	90	μS
Maximum Toff Time @ ILED=10mA, CLOAD=10pF (See Figure7)	220	μS

<b>GENERAL CHARACTERISTICS</b>	<b>Limits</b>	<b>Units</b>
Minimum Dielectric Strength, Input-Output	4000	V <sub>RMS</sub>
Minimum Dielectric Strength, Output-to-Output	1200	V <sub>DC</sub>
Minimum Insulation Resistance, Input-to-Output, @T <sub>A</sub> =+25°C, 50%RH, 100V <sub>DC</sub>	10 <sup>12</sup>	Ω
Maximum Pin Soldering Temperature (10 seconds maximum)	+260	°C
Ambient Temperature Range: Operating	-40 to 85	
Storage	-40 to 125	

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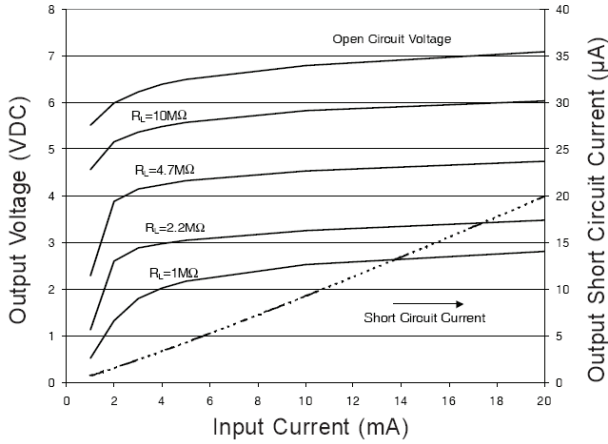


Figure 1. Typical Output Characteristics

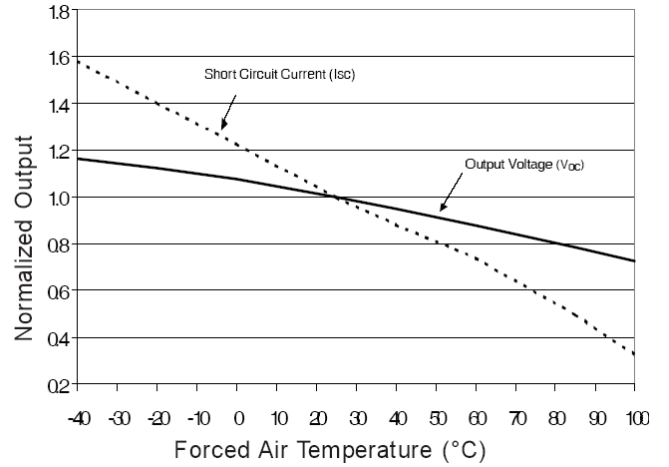


Figure 2. Typical Variation of Output

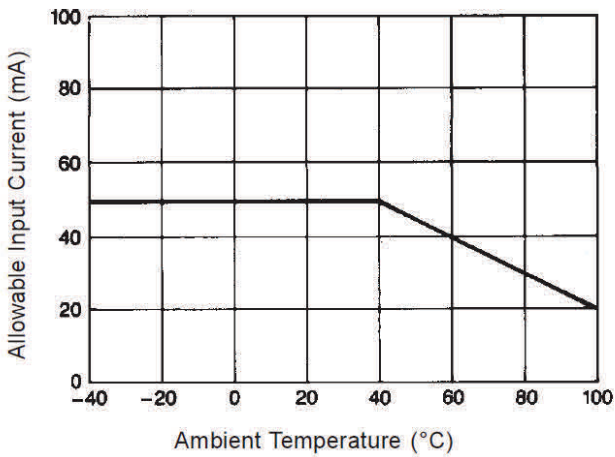


Figure 3. Input Current Derating

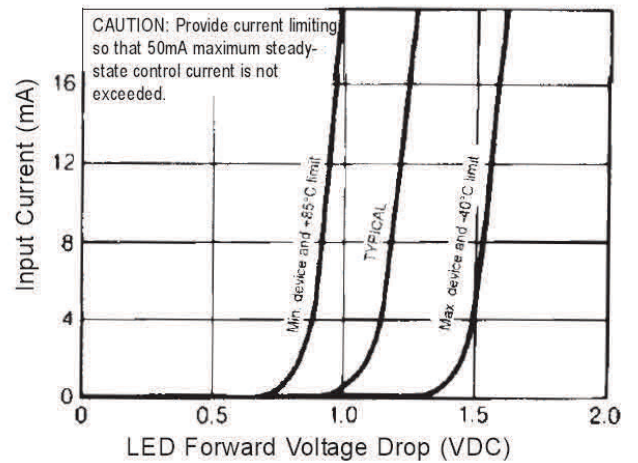


Figure 4. Input Characteristics

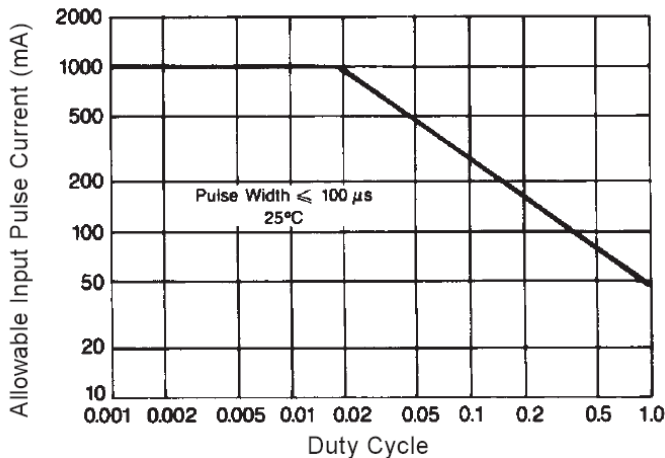


Figure 5. Input Pulse Capability

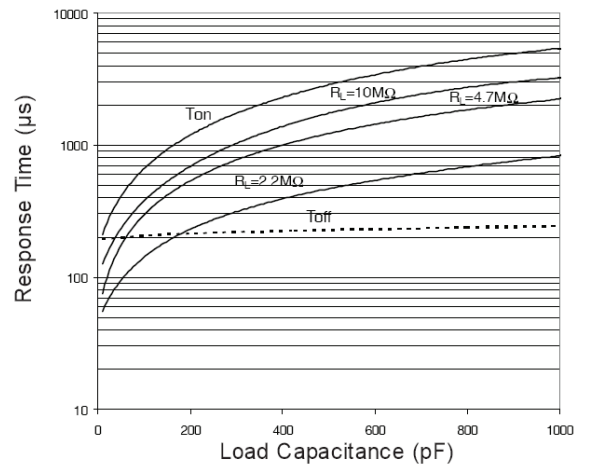
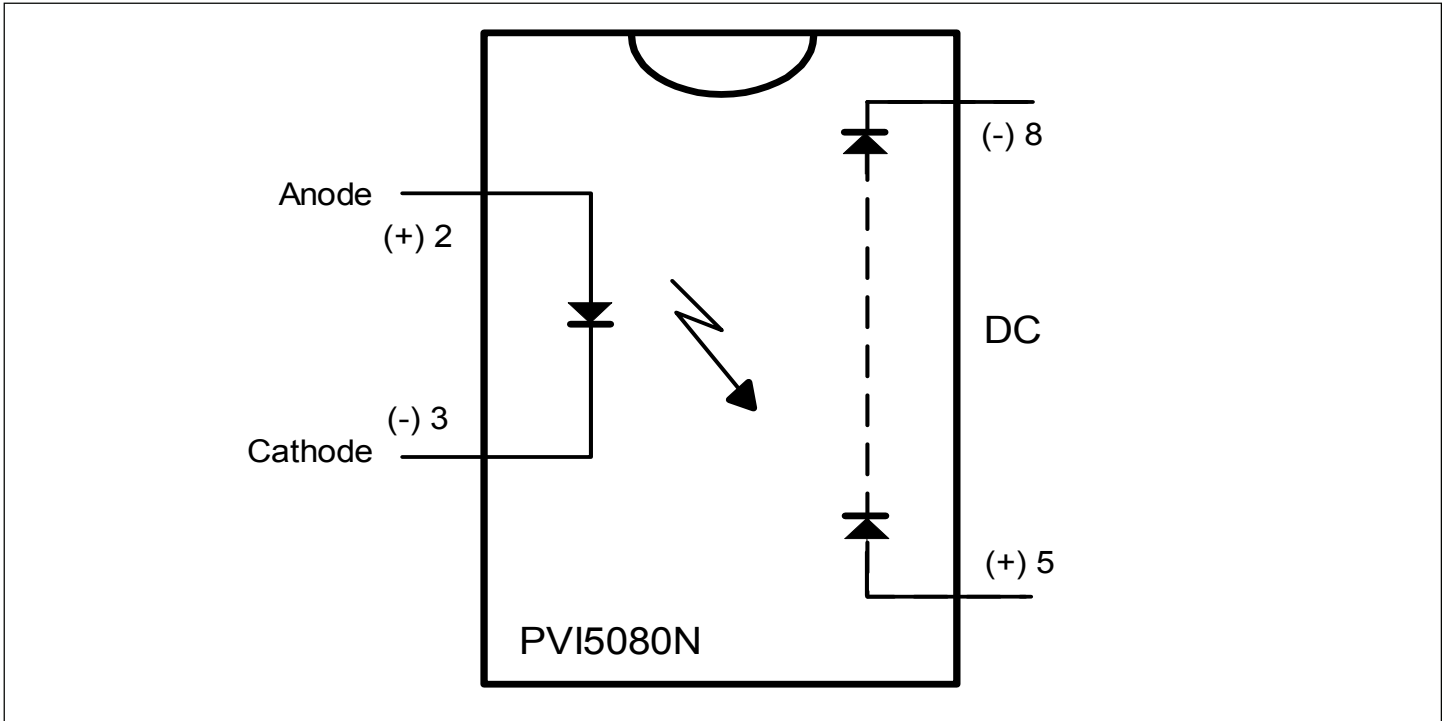
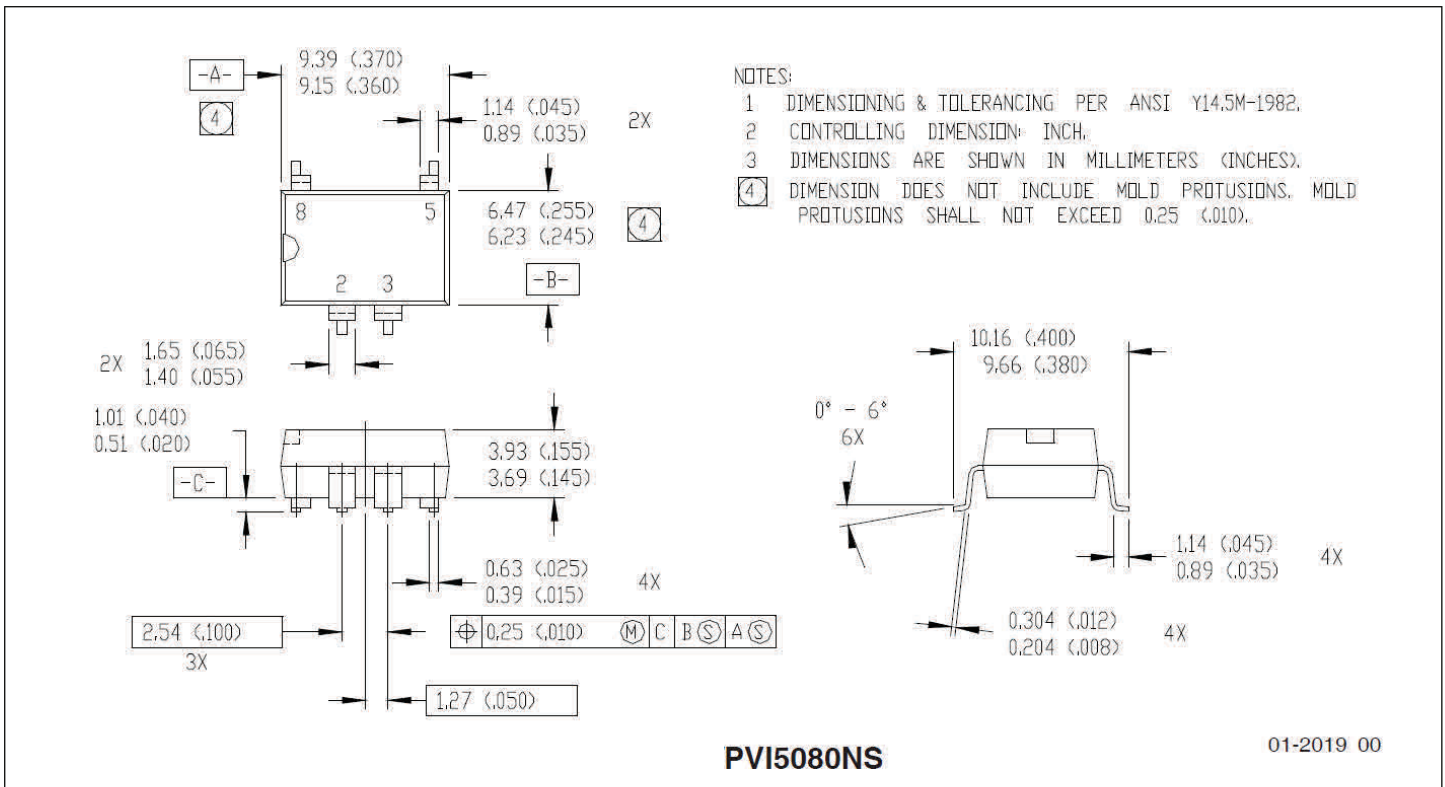
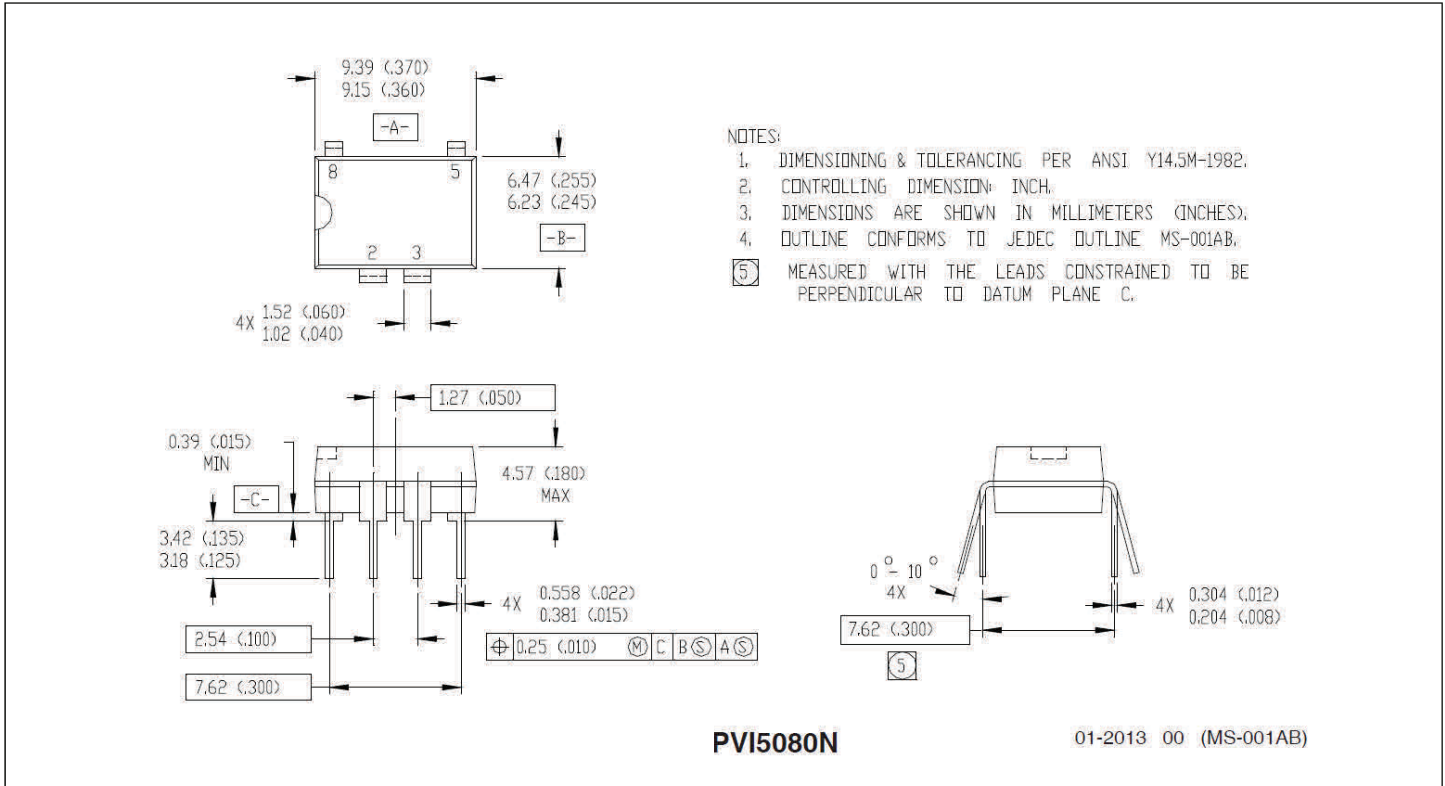


Figure 6. Typical Response Time

### Wiring Diagram



**Case Outlines**


**Qualification Information**

<b>Qualification Level</b>	Industrial (per JEDEC JESD47F <sup>†</sup> guidelines)	
<b>Moisture Sensitivity Level</b>	PVI5080NPbF	N/A
	PVI5080NSPbF	MSL4 (per JEDEC J-STD-020E & JEDEC J-STD-033C) <sup>†</sup>
<b>RoHS Compliant</b>	Yes	

<sup>†</sup> Applicable version of JEDEC standard at the time of product release.

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**Edition 2016-04-19**

**Published by**

**Infineon Technologies AG  
81726 Munich, Germany**

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